

Description

The BUK7208-40B uses advanced trench technology to provide excellent R_{DS(ON)}, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

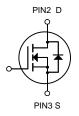


TO-252-2L

General Features

 $V_{DS} = 40V I_{D} = 60A$

 $R_{DS(ON)} < 10 m\Omega$ @ $V_{GS}=10V$



Application

Battery protection

Load switch

Uninterruptible power supply

N-Channel MOSFET

Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)
BUK7208-40B	TO252-2L	HXY MOSFET	2500

Absolute Maximum Ratings (T_c=25°C unless otherwise noted)

Symbol	Symbol Parameter		Units	
VDS	Drain-Source Voltage	40	V	
Vgs	Gate-Source Voltage	±20	V	
I _D @T _C =25°C	Continuous Drain Current, V _{GS} @ 10V ¹	urrent, V _{GS} @ 10V ¹ 60		
I _D @T _C =100°C	Continuous Drain Current, V _{GS} @ 10V ¹	Continuous Drain Current, V _{GS} @ 10V ¹ 40		
Ірм	Pulsed Drain Current ²	urrent ² 160		
EAS	Single Pulse Avalanche Energy ³	Avalanche Energy ³ 46.1		
las	Avalanche Current	28	А	
P _D @T _C =25°C	Total Power Dissipation⁴	34.6	W	
Тѕтс	Storage Temperature Range	-55 to 150	°C	
Τ _J	Operating Junction Temperature Range	-55 to 150	°C	
$R_{ heta}$ JA	Thermal Resistance Junction-ambient (Steady State)¹	62	°C/W	
ReJc	Thermal Resistance Junction-Case ¹	3.8	°C/W	



Electrical Characteristics (T_J=25°C unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units	
Off Charac	cteristic	1	1				
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	40	_	-	V	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =40V, V _{GS} =0V,	-	-	1.0	μA	
I _{GSS}	Gate to Body Leakage Current	V _{DS} =0V, V _{GS} =±20V	-	-	±100	nA	
On Characteristics							
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$, $I_D=250\mu A$	1.0	1.5	2.5	V	
	Static Drain-Source on-Resistance	V _{GS} =10V, I _D =30A	-	7.7	10	mΩ	
$R_{DS(on)}$		V _{GS} =4.5V, I _D =20A	-	10	14		
Dynamic (Characteristics						
C _{iss}	Input Capacitance	V _{DS} =20V, V _{GS} =0V,	-	1639	-	pF	
Coss	Output Capacitance		-	148	-	pF	
C _{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	122	-	pF	
Qg	Total Gate Charge	\/ 00\/ L 45A	-	16	-	nC	
Q _{gs}	Gate-Source Charge	V _{DS} =20V, I _D =15A,	-	5	-	nC	
Q_{gd}	Gate-Drain("Miller") Charge	V _{GS} =4.5V	-	7	-	nC	
Switching	Characteristics		•				
t _{d(on)}	Turn-on Delay Time		_	10	-	ns	
t _r	Turn-on Rise Time	V _{DS} =20V,I _D =1A,	-	6	-	ns	
$t_{d(off)}$	Turn-off Delay Time	R _{GEN} =6.2Ω, V _{GS} =10V	-	50	-	ns	
t _f	Turn-off Fall Time		-	26	-	ns	
Drain-Sou	rce Diode Characteristics and Maxim	um Ratings					
Is	Maximum Continuous Drain to Source Diode Forward Current		-	-	60	Α	
I _{SM}	Maximum Pulsed Drain to Source Dio	de Forward Current	_	-	160	Α	
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} =0V, I _S =30A	-	-	1.2	٧	
trr	Body Diode Reverse Recovery Time		-	13	-	ns	
Qrr	Body Diode Reverse Recovery Charge	I _F =5A,dI/dt=100A/μs	-	7	-	nC	

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

- 2. EAS condition: TJ=25 $^{\circ}\text{C}$, VGS=20V, RG=25 Ω , L=0.5mH, IAS=13A
- 3. Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%



Typical Performance Characteristics

Figure1: Output Characteristics

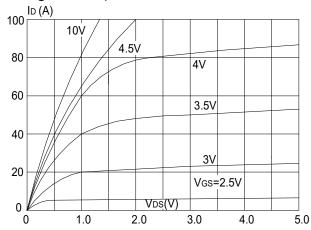


Figure 3:On-resistance vs. Drain Current

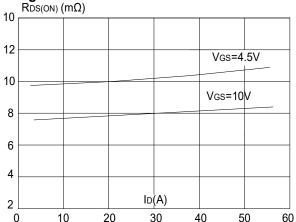


Figure 5: Gate Charge Characteristics

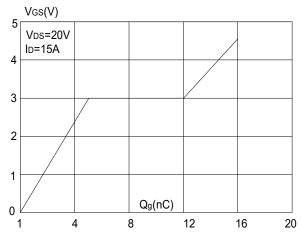


Figure 2: Typical Transfer Characteristics

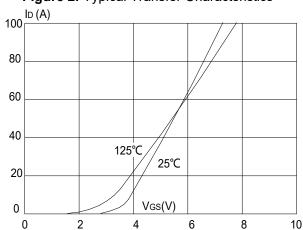


Figure 4: Body Diode Characteristics

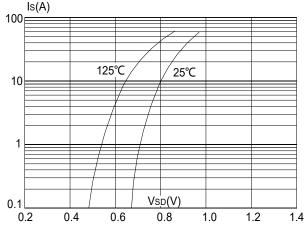


Figure 6: Capacitance Characteristics

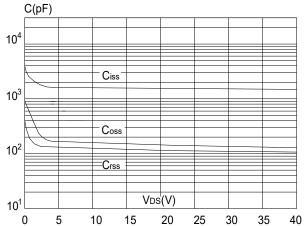




Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

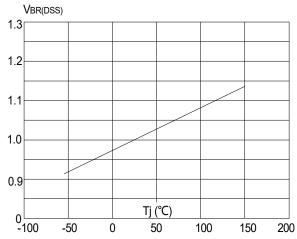


Figure 9: Maximum Safe Operating Area

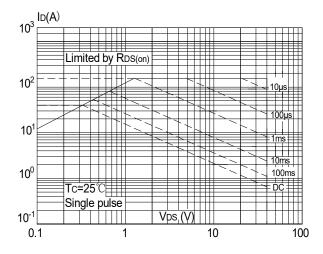


Figure.11: Maximum Effective Transient Thermal Impedance, Junction-to-Case

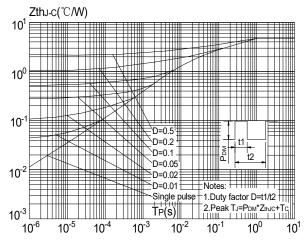


Figure 8: Normalized on Resistance vs. Junction Temperature

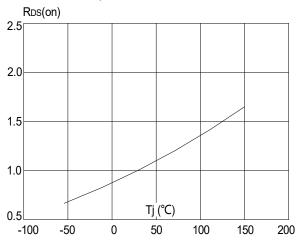
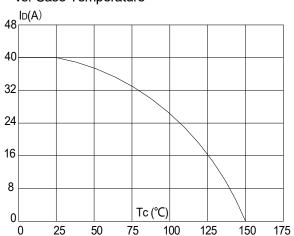


Figure 10: Maximum Continuous Drain Current vs. Case Temperature





Test Circuit

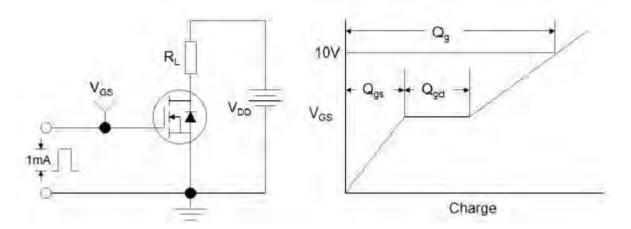


Figure1:Gate Charge Test Circuit & Waveform

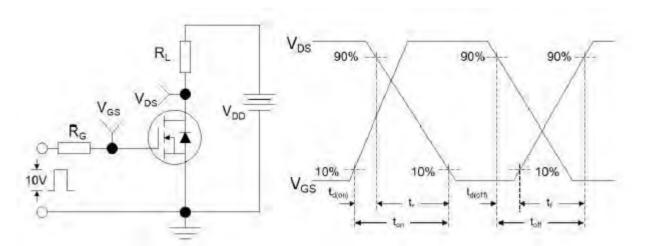


Figure 2: Resistive Switching Test Circuit & Waveforms

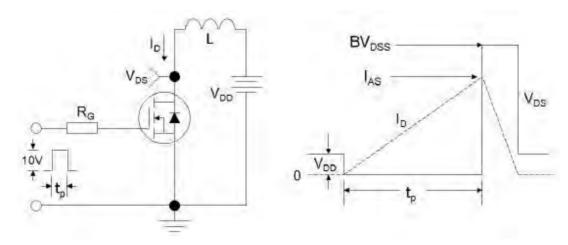
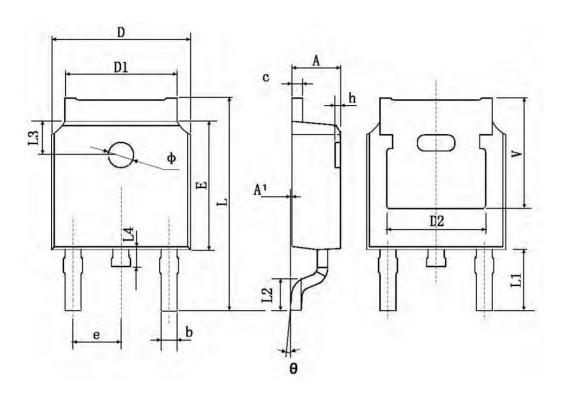


Figure 3:Unclamped Inductive Switching Test Circuit & Waveforms



TO-252 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
A	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.660	0.860	0.026	0.034	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	0.483 TYP.		0.190 TYP.		
E	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.800	10.400	0.386	0.409	
L1	2.900 TYP.		0.114 TYP.		
L2	1.400	1.700	0.055	0.067	
L3	1.600	1.600 TYP.		0.063 TYP.	
L4	0.600	1.000	0.024	0.039	
Ф	1.100	1.300	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.350	TYP.	0.211 TYP.		



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